Data sheet acquired from Cypress Semiconductor Corporation.
Data sheet modified to remove devices not offered.

CY74FCT16244T
CY74FCT162244T
CY74FCT162H244T

16-Bit Buffers/Line Drivers

SCCS028B - December 1987 - Revised September 2001

Features

- **I_{off} supports partial-power-down mode operation**
- **Edge-rate control circuitry for significantly improved noise characteristics**
- **Typical output skew < 250 ps**
- **ESD > 2000V**
- **TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages**
- **Industrial temperature range of –40˚C to +85˚C**
- **V_{CC} = 5V ± 10%**

CY74FCT16244T Features:

- **64 mA sink current, 32 mA source current**
- **Typical V_{OLP} (ground bounce) <1.0V at V_{CC} = 5V, T_A = 25˚C**

CY74FCT162244T Features:

- **Balanced output drivers: 24 mA**
- **Reduced system switching noise**
- **Typical V_{OLP} (ground bounce) <0.6V at V_{CC} = 5V, T_A= 25˚C**

CY74FCT162H244T Features:

- **Bus hold on data inputs**
- **Eliminates the need for external pull-up or pull-down resistors**

Functional Description

These 16-bit buffers/line drivers are designed for use in memory driver, clock driver, or other bus interface applications, where high-speed and low power are required. With flow-through pinout and small shrink packaging board layout is simplified. The three-state controls are designed to allow 4-bit, 8-bit or combined 16-bit operation.

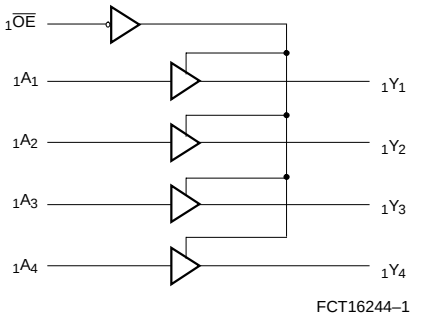
This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The CY74FCT16244T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

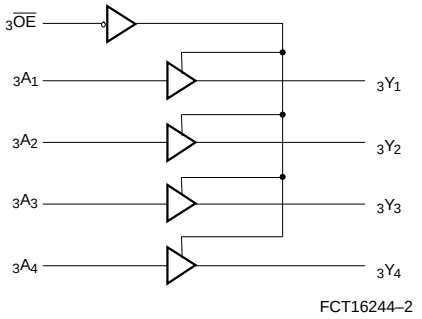
The CY74FCT162244T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162244T is ideal for driving transmission lines.

The CY74FCT162H244T is a 24-mA balanced output part that has “bus hold” on the data inputs. The device retains the input’s last state whenever the input goes to high impedance. This eliminates the need for pull-up/down resistors and prevents floating inputs.

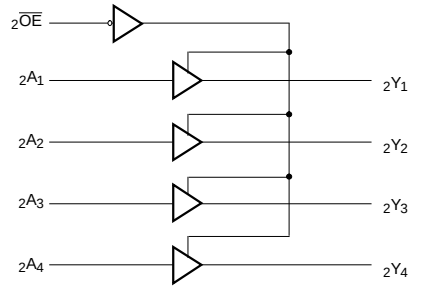
Logic Block Diagrams CY74FCT16244T, CY74FCT162244T, CY74FCT162H244T



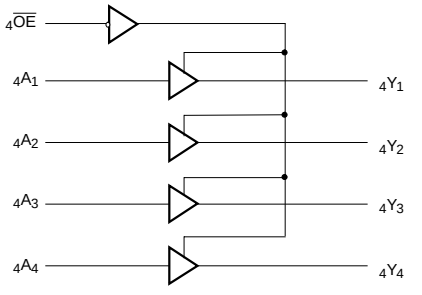
FCT16244–1



FCT16244–2



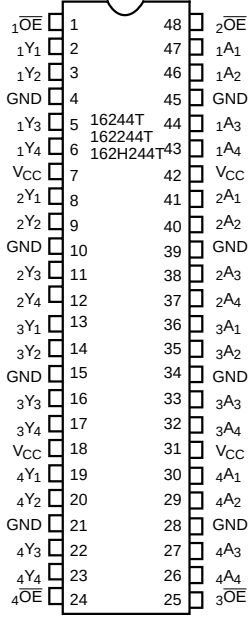
FCT16244–3



FCT16244–4

Pin Configuration

SSOP/TSSOP Top View



FCT16244–5

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Pin Description

Name	Description
$\overline{OE}$	Three-State Output Enable Inputs (Active LOW)
A	Data Inputs[1]
Y	Three-State Outputs

Function Table[2]

Inputs		Outputs
$\overline{OE}$	A	Y
L	L	L
L	H	H
H	X	Z

Maximum Ratings [3,4]

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... –55°C to +125°C

Ambient Temperature with Power Applied ..... –55°C to +125°C

DC Input Voltage ..... –0.5V to +7.0V

DC Output Voltage ..... –0.5V to +7.0V

DC Output Current (Maximum Sink Current/Pin) ..... –60 to +120 mA

Power Dissipation 1.0W

Static Discharge Voltage ..... >2001V (per MIL-STD-883, Method 3015)

Ordering Range

Range	Ambient Temperature	V_{CC}
Industrial	– 40°C to +85°C	5V ± 10%

Notes:
1. On CY74FCT162H244T these pins have “bus hold.”
2. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don’t Care. Z = High Importance.
3. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.
4. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

Electrical Characteristics Over the Operating Range

Parameter	Description		Test Conditions		Min.	Typ.[5]	Max.	Unit
V_{IH}	Input HIGH Voltage				2.0			V
V_{IL}	Input LOW Voltage						0.8	V
V_H	Input Hysteresis[6]					100		mV
V_{IK}	Input Clamp Diode Voltage		V_{CC}=Min., I_{IN}=–18 mA			–0.7	–1.2	V
I_{IH}	Input HIGH Current	Standard	V_{CC}=Max., V_I=V_{CC}				±1	µA
		Bus Hold					±100	
I_{IL}	Input LOW Current	Standard	V_{CC}=Max., V_I=GND				±1	µA
		Bus Hold					±100	µA
I_{BBH} I_{BBL}	Bus Hold Sustain Current on Bus Hold Input[7]		V_{CC}=Min.	V_I=2.0V	–50			µA
				V_I=0.8V	+50			
I_{BHHO} I_{BHLO}	Bus Hold Overdrive Current on Bus Hold Input[7]		V_{CC}=Max., V_I=1.5V				TBD	mA
I_{OZH}	High Impedance Output Current (Three-State Output pins)		V_{CC}=Max., V_{OUT}=2.7V				±1	µA
I_{OZL}	High Impedance Output Current (Three-State Output pins)		V_{CC}=Max., V_{OUT}=0.5V				±1	µA
I_{OS}	Short Circuit Current[8]		V_{CC}=Max., V_{OUT}=GND		–80	–140	–200	mA
I_O	Output Drive Current[8]		V_{CC}=Max., V_{OUT}=2.5V		–50		–180	mA
I_{OFF}	Power-Off Disable		V_{CC}=0V, V_{OUT}≤4.5V[9]				±1	µA

Output Drive Characteristics for CY74FCT16244T

Parameter	Description	Test Conditions	Min.	Typ.[5]	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC}=Min., I_{OH}=–3 mA	2.5	3.5		V
		V_{CC}=Min., I_{OH}=–15 mA	2.4	3.5		V
		V_{CC}=Min., I_{OH}=–32 mA	2.0	3.0		V
V_{OL}	Output LOW Voltage	V_{CC}=Min., I_{OL}=64 mA		0.2	0.55	V

Output Drive Characteristics for CY74FCT162244T, CY74FCT162H244T

Parameter	Description	Test Conditions	Min.	Typ.[5]	Max.	Unit
I_{ODL}	Output LOW Current[8]	V_{CC}=5V, V_{IN}=V_{IH} or V_{IL}, V_{OUT}=1.5V	60	115	150	mA
I_{ODH}	Output HIGH Current[8]	V_{CC}=5V, V_{IN}=V_{IH} or V_{IL}, V_{OUT}=1.5V	–60	–115	–150	mA
V_{OH}	Output HIGH Voltage	V_{CC}=Min., I_{OH}=–24 mA	2.4	3.3		V
V_{OL}	Output LOW Voltage	V_{CC}=Min., I_{OL}=24 mA		0.3	0.55	V

Notes:

5. Typical values are at V_{CC}=5.0V, T_A = +25˚C ambient.
6. This parameter is specified but not tested.
7. Pins with bus hold are described in Pin Description.
8. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.
9. Tested at +25˚C.

Capacitance[6] (T_A = +25°C, f = 1.0 MHz)

Parameter	Description	Test Conditions	Typ.[5]	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	4.5	6.0	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	5.5	8.0	pF

Power Supply Characteristics

Parameter	Description	Test Conditions		Typ.[5]	Max.	Unit
I_{CC}	Quiescent Power Supply Current	V_{CC}=Max.	$V_{IN}\leq$0.2V, $V_{IN}\leq V_{CC}$-0.2V	5	500	µA
ΔI_{CC}	Quiescent Power Supply Current (TTL inputs HIGH)	V_{CC}=Max.	V_{IN}=3.4V[10]	0.5	1.5	mA
I_{CCD}	Dynamic Power Supply Current[11]	V_{CC}=Max., One Input Toggling, 50% Duty Cycle, Outputs Open, $\overline{OE}$=GND	$V_{IN}=V_{CC}$ or V_{IN}=GND	60	100	µA/MHz
I_C	Total Power Supply Current[12]	V_{CC}=Max., f_1=10 MHz, 50% Duty Cycle, Outputs Open, One Bit Toggling, $\overline{OE}$=GND	$V_{IN}=V_{CC}$ or V_{IN}=GND	0.6	1.5	mA
			V_{IN}=3.4V or V_{IN}=GND	0.9	2.3	mA
		V_{CC}=Max., f_1=2.5 MHz, 50% Duty Cycle, Outputs Open, Sixteen Bits Toggling, $\overline{OE}$=GND	$V_{IN}=V_{CC}$ or V_{IN}=GND	2.4	4.5[13]	mA
			V_{IN}=3.4V or V_{IN}=GND	6.4	16.5[13]	mA

Notes:

10. Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
11. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
12. $I_C=I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
    $I_C = I_{CC}+\Delta I_{CC}D_HN_T+I_{CCD}(f_0/2 + f_1N_1)$
    I_{CC} = Quiescent Current with CMOS input levels
    I_{CC} = Power Supply Current for a TTL HIGH input (V_{IN}=3.4V)
    D_H = Duty Cycle for TTL inputs HIGH
    N_T = Number of TTL inputs at D_H
    I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL)
    f_0 = Clock frequency for registered devices, otherwise zero
    f_1 = Input signal frequency
    N_1 = Number of inputs changing at f_1
    All currents are in milliamps and all frequencies are in megahertz.
13. Values for these conditions are examples of the I_{CC} formula. These limits are specified but not tested.

Switching Characteristics Over the Operating Range[14]

Parameter	Description	CY74FCT16244T CY74FCT162244T		CY74FCT16244AT CY74FCT162244AT CY74FCT162H244AT		Unit	Fig. No.[15]
		Min.	Max.	Min.	Max.		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.5	6.5	1.5	4.8	ns	1, 3
t_{PZH} t_{PZL}	Output Enable Time	1.5	8.0	1.5	6.2	ns	1, 7, 8
t_{PHZ} t_{PLZ}	Output Disable Time	1.5	7.0	1.5	5.6	ns	1, 7, 8
$t_{SK(O)}$	Output Skew[16]		0.5		0.5	ns	—

Switching Characteristics Over the Operating Range[14] (continued)

Parameter	Description	CY74FCT16244CT CY74FCT162244CT CY74FCT162H244CT		Unit	Fig. No.[15]
		Min.	Max.		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.5	4.1	ns	1, 3
t_{PZH} t_{PZL}	Output Enable Time	1.5	5.8	ns	1, 7, 8
t_{PHZ} t_{PLZ}	Output Disable Time	1.5	5.2	ns	1, 7, 8
$t_{SK(O)}$	Output Skew[16]		0.5	ns	—

Notes:
14. Minimum limits are specified but not tested on Propagation Delays.
15. See “Parameter Measurement Information” in the General Information section.
16. Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

Ordering Information CY74FCT16244

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	CY74FCT16244CTPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16244CTPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
4.8	CY74FCT16244ATPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16244ATPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
6.5	CY74FCT16244TPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16244TPVC/PVCT	O48	48-Lead (300-Mil) SSOP	

Ordering Information CY74FCT162244

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	74FCT162244CTPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162244CTPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162244CTPVCT	O48	48-Lead (300-Mil) SSOP	
4.8	74FCT162244ATPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162244ATPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162244ATPVCT	O48	48-Lead (300-Mil) SSOP	
6.5	CY74FCT162244TPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162244TPVC/PVCT	O48	48-Lead (300-Mil) SSOP	

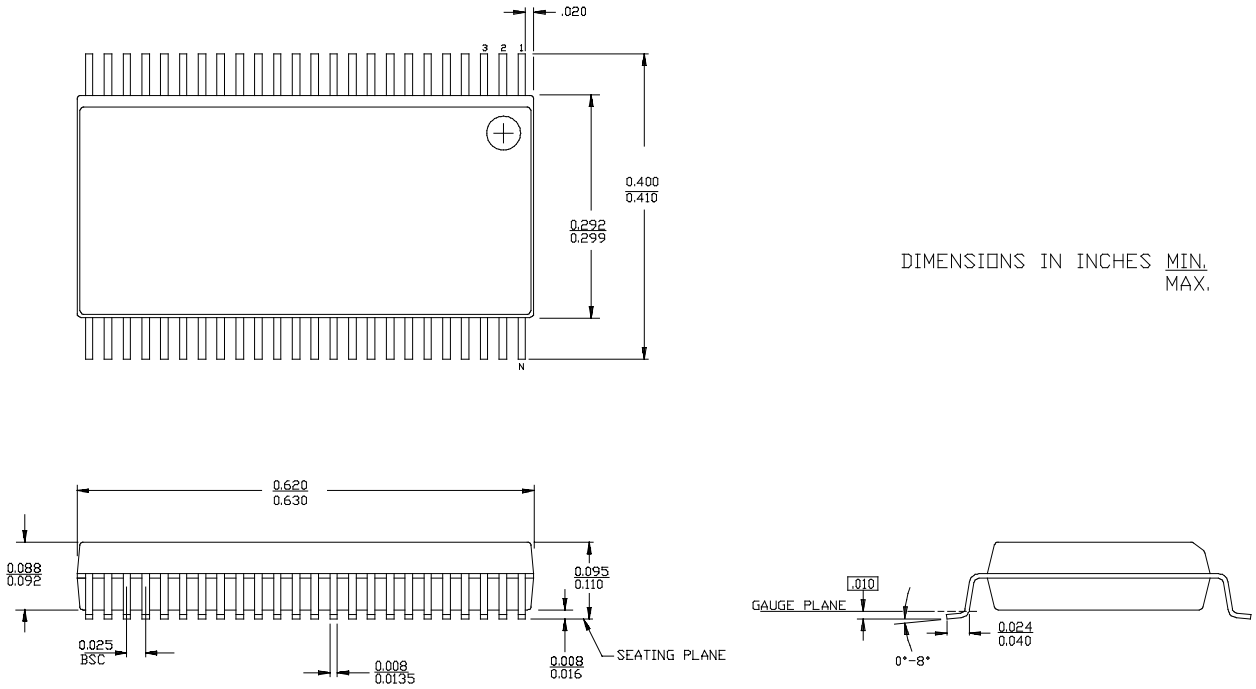
Ordering Information CY74FCT162H244

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	74FCT162H244CTPVC/PVCT	O48	48-Lead (300-Mil) SSOP	Industrial
4.8	74FCT162H244ATPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial

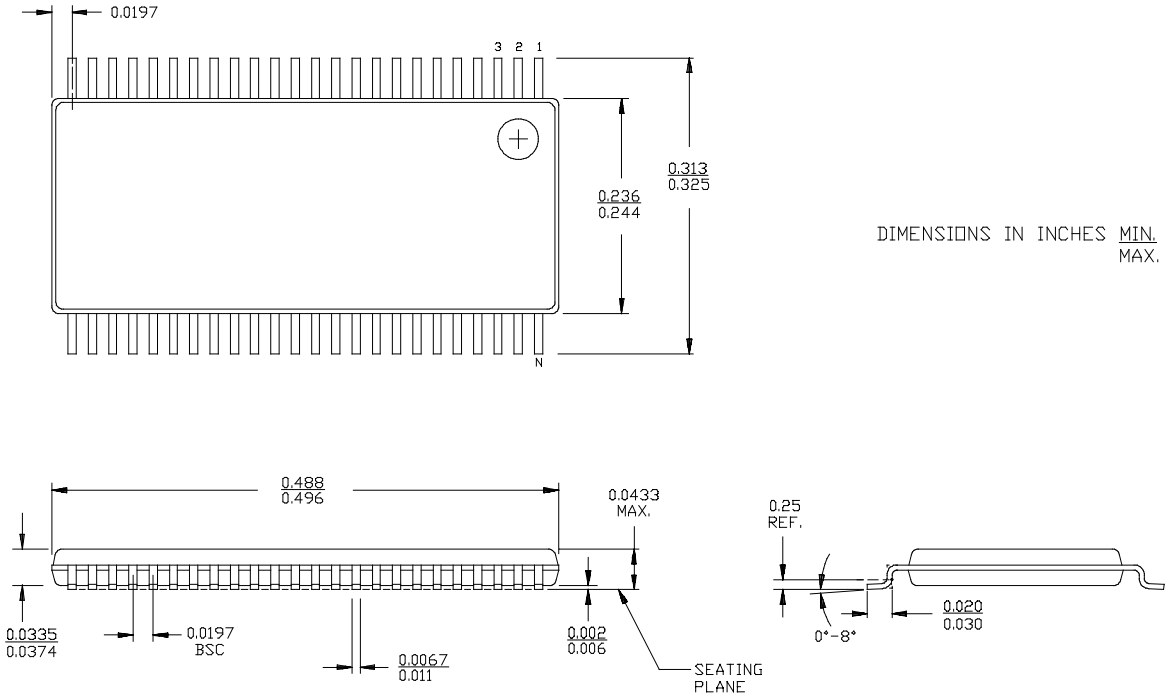
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Package Diagrams

48-Lead Shrunk Small Outline Package O48



48-Lead Thin Shrunk Small Outline Package Z48



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